

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	12256	(copper near4 electroplating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:34
S2	1078	S1 same (additives or promoter or retardant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:35
S3	638	S2 and (current near4 density)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:39
S4	389	S3 and cathode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:39
S5	260	S4 and ((@ad<"20030325") or (@rlad<"20030325"))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:40
S6	56352	Toppan.as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:41
S7	280580	Okubo.in. or Naoi.in. or Yamada.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:41
S9	2	("5223118").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/27 17:46

S10	104	(promoter or accelerator) same (retardant or suppressor or inhibitor) same (current near density)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:35
S11	10834	Boltzmann	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:36
S12	0	S10 and S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:36
S13	1	Boltzmann same (copper near4 electroplat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:36
S14	42254	(Boltzmann or (time \$dependent))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:37
S15	0	S10 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:37
S16	1	S14 same (copper near4 electroplat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 10:37
S17	104	(promoter or accelerator) same (retardant or suppressor or inhibitor) same (current near density)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 16:16
S18	52	S17 and apparatus	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/29 16:16

S19	2	("20080090333").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/29 17:53
S20	506	(Cyclic near voltammetry)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 10:31
S21	4391	(plating or electroplating) same trench same copper	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 10:31
S22	1	S20 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 10:31
S23	0	(11/727357).APP.	USPAT; USOCR	OR	ON	2008/12/30 13:52
S24	104	(promoter or accelerator) same (retardant or suppressor or inhibitor) same (current near density)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 13:53
S25	52	S24 and apparatus	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 13:53
S26	28	S25 and ((@ad<"20030325") or (@rlad<"20030325"))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/30 13:53
S27	2	("6921551").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/31 10:09

12/31/2008 2:59:04 PM

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